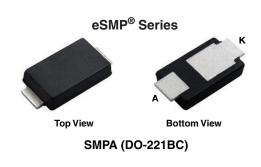
ROHS

**HALOGEN** 



Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



Anode Cathode

#### LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	3.0 A			
$V_{RRM}$	50 V			
I <sub>FSM</sub>	80 A			
$V_F$ at $I_F = 3.0$ A $(T_A = 125  ^{\circ}C)$	0.40 V			
T <sub>J</sub> max.	150 °C			
Package	SMPA (DO-221BC)			
Circuit configuration	Single			

### **FEATURES**

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

#### **MECHANICAL DATA**

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V3PAN50	UNIT	
Device marking code		3N5		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	V	
Maximum DC forward current	I <sub>F</sub> <sup>(1)</sup>	3.0	А	
Maximum DC reverse voltage	V <sub>DC</sub>	35	V	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	80	А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +150	°C	

#### Note

(1) Free air, mounted on recommended copper pad area

Revision: 16-Jun-2020 **1** Document Number: 87909 For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u>



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 1.5 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> (1)	0.40	-	V
	$I_F = 3.0 A$			0.47	0.54	
	I <sub>F</sub> = 1.5 A	T <sub>A</sub> = 125 °C		0.30	-	
	I <sub>F</sub> = 3.0 A			0.40	0.48	
Reverse current	V <sub>R</sub> = 35 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	8	-	μΑ
	v <sub>R</sub> = 35 v	T <sub>A</sub> = 125 °C		8.8	-	mA
	V 50.V	T <sub>A</sub> = 25 °C		-	600	μA
	$V_R = 50 \text{ V}$	T <sub>A</sub> = 125 °C		12	35	mA
Typical junction capacitance	4.0 V, 1 MF	4.0 V, 1 MHz		480	-	pF

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)			
PARAMETER	SYMBOL V3PAN50		UNIT
Typical thermal resistance	R <sub>0JA</sub> (1)	100	°C/W
Typical thermal resistance	R <sub>0JM</sub> (1)	9	C/VV

#### Note

(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient;  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
V3PAN50-M3/I	0.032	I	14 000	13" diameter plastic tape and reel		

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise specified)

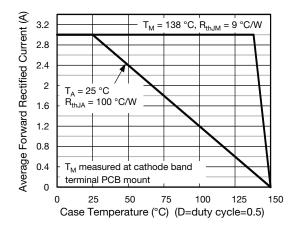


Fig. 1 - Maximum Forward Current Derating Curve

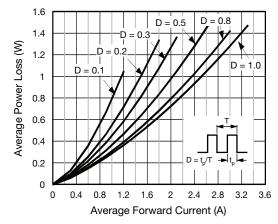


Fig. 2 - Forward Power Loss Characteristics

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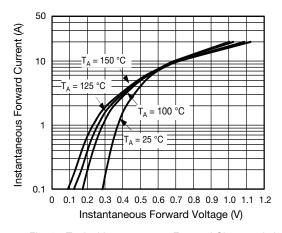


Fig. 3 - Typical Instantaneous Forward Characteristics

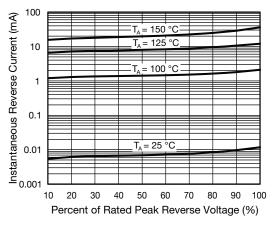


Fig. 4 - Typcial Reverse Leakage Characteristics

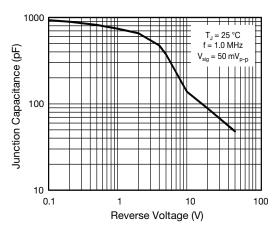


Fig. 5 - Typical Junction Capacitance

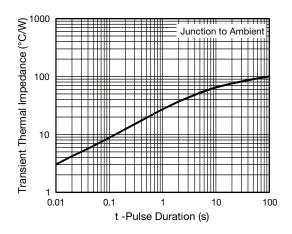


Fig. 6 - Typcial Transient Thermal Impedance

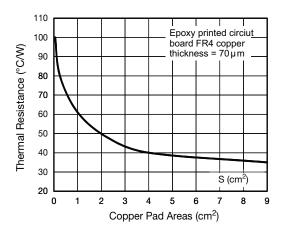


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

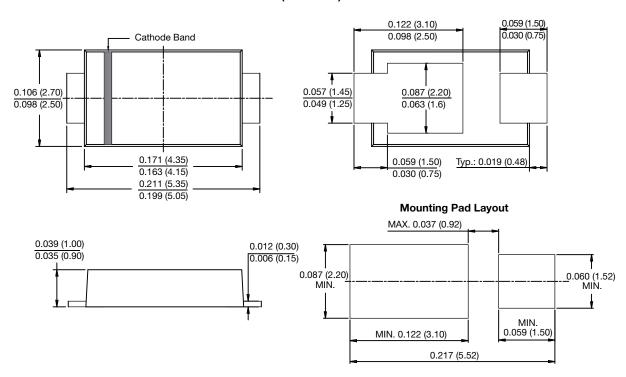


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## **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

#### **SMPA (DO-221BC)**



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